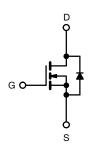


Vishay Siliconix

# **E Series Power MOSFET**





N-Channel MOSFET

PRODUCT SUMMARY				
$V_{DS}$ (V) at $T_J$ max.	700			
R <sub>DS(on)</sub> (Ω) typ. at 25 °C	V <sub>GS</sub> = 10 V	0.025		
Q <sub>g</sub> (nC) max.	591			
Q <sub>gs</sub> (nC)	84			
Q <sub>gd</sub> (nC)	160			
Configuration	Single			

### **FEATURES**

• Low figure-of-merit (FOM) Ron x Qq



· Reduced switching and conduction losses



Avalanche energy rated (UIS)

 Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

Ph	



### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	Super-247
Lead (Pb)-free	SiHS90N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	650	V	
Gate-source voltage			$V_{GS}$	± 30	]	
Continuous drain current (T <sub>.I</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	1	87		
Continuous drain current (1j = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	Ι <sub>D</sub>	55	Α	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	323	I	
Linear derating factor				5	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	1930	mJ	
Maximum power dissipation			$P_{D}$	625	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope T <sub>J</sub> = 125 °C		-IV / / -I ±	41	V/ns		
Reverse diode dV/dt <sup>d</sup>			dV/dt	4.1	V/IIS	
Soldering recommendations (peak temperature) c for 10 s			300	°C		

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 11.7 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ ,  $dI/dt = 100 \text{ A/}\mu\text{s}$ , starting  $T_J = 25 \,^{\circ}\text{C}$



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-	40	°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	0.2	C/VV		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		_		l	•	l .	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	650	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA		0.83	-	V/°C
Gate threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-source leakage	Lana	V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
date-source leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>		= 650 V, V <sub>GS</sub> = 0 V	-	-	1	μA
Zoro gato voltago drain ounont	טאטי		$V_{\rm S} = 0 \ V_{\rm T} = 125 \ ^{\circ}{\rm C}$	-	-	25	μπ
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}$	$I_D = 45 A$	-	0.025	0.029	Ω
Forward transconductance a	9 <sub>fs</sub>	$V_{DS}$	= 30 V, I <sub>D</sub> = 45 A		32	-	S
Dynamic							
Input capacitance	$C_{iss}$	$V_{GS} = 0 \text{ V},$		-	11 826	-	
Output capacitance	$C_{oss}$		$V_{DS} = 100 \text{ V},$		528	-	
Reverse transfer capacitance	$C_{rss}$	f = 300 kHz		-	9	-	
Effective output capacitance, energy related <sup>a</sup>	$C_{o(er)}$	$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{ V to } 520 \text{ V}$		-	384	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	1502	-	
Total gate charge	Qg			-	394	591	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 45 \text{ A}, V_{DS} = 520 \text{ V}$		84	-	nC
Gate-drain charge	Q <sub>gd</sub>	7		-	160	-	
Turn-on delay time	t <sub>d(on)</sub>				85	128	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	= 520 V, I <sub>D</sub> = 45 A,	-	152	228	
Turn-off delay time	t <sub>d(off)</sub>		= 10 V, $R_g = 9.1 \Omega$	=.	323	485	ns
Fall time	t <sub>f</sub>	7		-	267	401	
Gate input resistance	$R_g$	f = 1 MHz, open drain		0.6	1.2	2.4	Ω
Drain-Source Body Diode Characteristic	s						•
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	87	
Pulsed diode forward current	I <sub>SM</sub>			_	-	323	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 45 A, V <sub>GS</sub> = 0 V	-	0.9	1.2	V
Reverse recovery time	t <sub>rr</sub>			-	971	1942	ns
Reverse recovery charge	Q <sub>rr</sub>		5 °C, I <sub>F</sub> = I <sub>S</sub> = 45 A,	-	26	52	μC
Reverse recovery current	I <sub>RRM</sub>		100 A/ $\mu$ s, V <sub>R</sub> = 25 V	_	42	_	Α

### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$
- b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

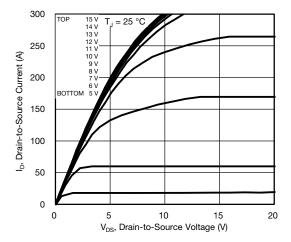


Fig. 1 - Typical Output Characteristics

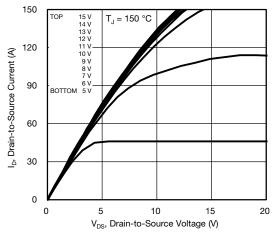


Fig. 2 - Typical Output Characteristics

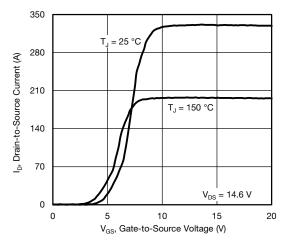


Fig. 3 - Typical Transfer Characteristics

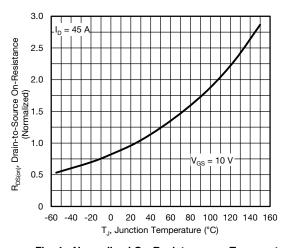


Fig. 4 - Normalized On-Resistance vs. Temperature

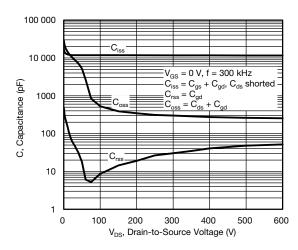


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

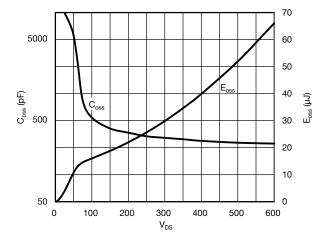


Fig. 6 - Coss and Eoss vs. VDS



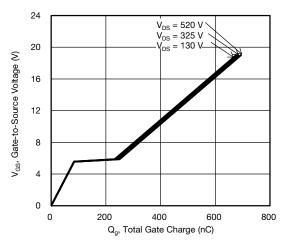


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

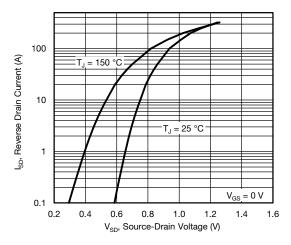


Fig. 8 - Typical Source-Drain Diode Forward Voltage

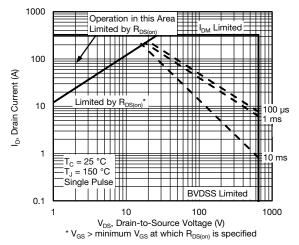


Fig. 9 - Maximum Safe Operating Area

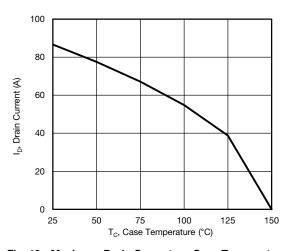


Fig. 10 - Maximum Drain Current vs. Case Temperature

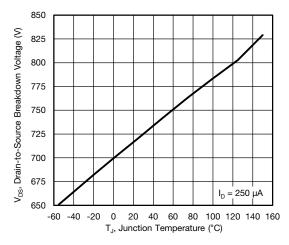


Fig. 11 - Temperature vs. Drain-to-Source Voltage



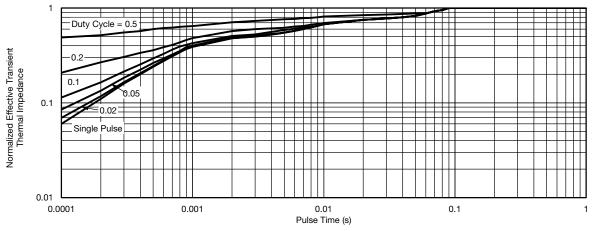


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

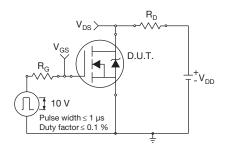


Fig. 13 - Switching Time Test Circuit

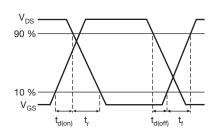


Fig. 14 - Switching Time Waveforms

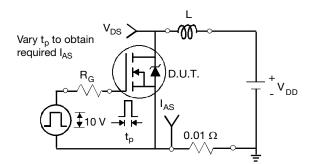


Fig. 15 - Unclamped Inductive Test Circuit

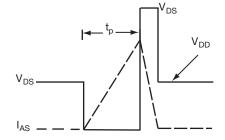


Fig. 16 - Unclamped Inductive Waveforms

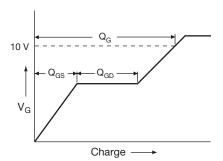


Fig. 17 - Basic Gate Charge Waveform

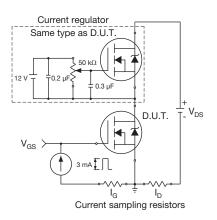
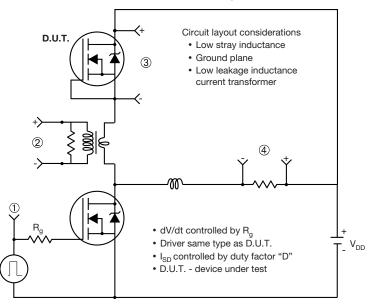


Fig. 18 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



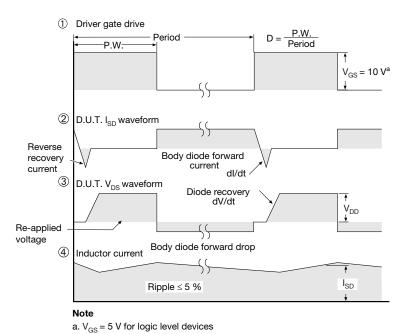


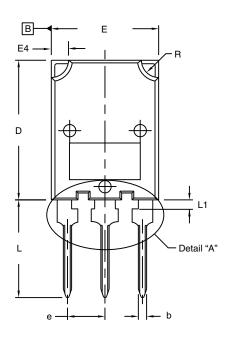
Fig. 19 - For N-Channel

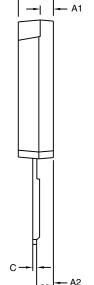
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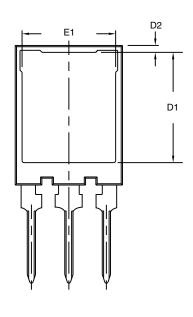
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# **TO-274AA (High Voltage)**

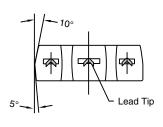
### **VERSION 1: FACILITY CODE = Y**

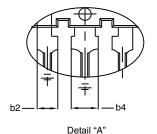






♦ 0.10 (0.25) ♠ B A ♠





Scale: 2:1

MILLIMETERS		INC	HES
MIN.	MAX.	MIN.	MAX.
4.70	5.30	0.185	0.209
1.50	2.50	0.059	0.098
2.25	2.65	0.089	0.104
1.30	1.60	0.051	0.063
1.80	2.20	0.071	0.087
3.00	3.25	0.118	0.128
0.38	0.89	0.015	0.035
19.80	20.80	0.780	0.819
	MIN. 4.70 1.50 2.25 1.30 1.80 3.00 0.38	MIN.         MAX.           4.70         5.30           1.50         2.50           2.25         2.65           1.30         1.60           1.80         2.20           3.00         3.25           0.38         0.89	MIN.         MAX.         MIN.           4.70         5.30         0.185           1.50         2.50         0.059           2.25         2.65         0.089           1.30         1.60         0.051           1.80         2.20         0.071           3.00         3.25         0.118           0.38         0.89         0.015

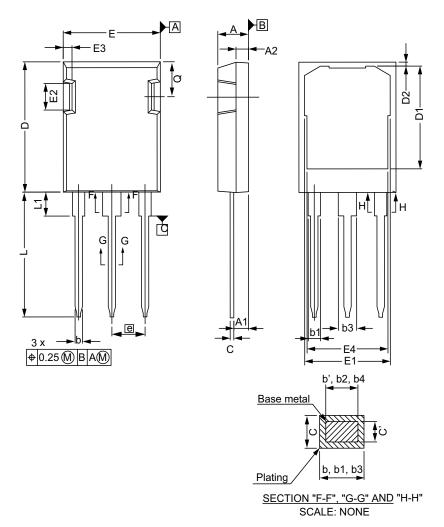
	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	15.50	16.10	0.610	0.634
D2	0.70	1.30	0.028	0.051
Е	15.10	16.10	0.594	0.634
E1	13.30	13.90	0.524	0.547
е	5.45 BSC		0.215	BSC
L	13.70	14.70	0.539	0.579
L1	1.00	1.60	0.039	0.063
R	2.00	3.00	0.079	0.118

### Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outer extremes of the plastic body
- Outline conforms to JEDEC® outline to TO-274AA
- (1) Dimension measured at tip of lead



### **VERSION 2: FACILITY CODE = N**



	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	4.83	5.21	
A1	2.29	2.54	
A2	1.91	2.16	
b'	1.07	1.28	
b	1.07	1.33	
b1	1.91	2.41	
b2	1.91	2.16	
b3	2.87	3.38	
b4	2.87	3.13	
c'	0.55	0.65	
С	0.55	0.68	
D	20.80	21.10	

MILLIMETERS		
MIN.	MAX.	
16.25	17.65	
0.50	0.80	
15.75	16.13	
13.10	14.15	
3.68	5.10	
1.00	1.90	
12.38	13.43	
5.44 BSC		
3		
19.81	20.32	
3.70	4.00	
5.49	6.00	
	16.25 0.50 15.75 13.10 3.68 1.00 12.38 5.44 3.70	

ECN: E20-0538-Rev. C, 19-Oct-2020

DWG: 5975

- Dimensioning and tolerancing per ASME Y14.5M-1994 Outline conforms to JEDEC® outline to TO-274AD Dimensions are measured in mm, angles are in degree
- Metal surfaces are tin plated, except area of cut



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Vishay

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